APPLICA	BLE STAN	DARD								
	OPERATING TEMPERATURE RANGE		-35°C TO +85 °C(N	IOTE 1)	STORA	GE RATURE RAN	GE	-10°C TO +60°C(N	OTE	3)
RATING	OPERATING HUMIDITY RANGE		20 % TO 80 % (NC	80 % (NOTE 2) STO		RAGE IIDITY RANGE		40 % TO 70 %(NO		3)
	VOLTAGE		AC 150 V	APPL		ABLE ECTOR		DF13-*S-1.25		
	CURRENT		1 A		APPLIC CONTA	ABLE		DF13(G)-2630S0 DF13-3032SC		
			SPEC	IFICA	TION	S		DI 10-303230	<u> </u>	
IT	EM		TEST METHOD				REQUI	REMENTS	QT	AT
	UCTION	1			1					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			A	ACCORDING TO DRAWING.				Χ
MARKING		CONFIRMED VISUALLY.								Χ
		CTERISTICS				20 mg MAV				1
CONTACT RESISTANCE INSULATION		100 m A (DC OR 1000 Hz).				30 mΩ MAX. 500 MΩ MIN.			X	_
RESISTANCE		100 V DC.				500 MΩ MIN.				_
VOLTAGE PROOF		500 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				_
	IICAL CHA									
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.				<ol> <li>CONTACT RESISTANCE: 30 mΩ MAX.</li> <li>NO DAMAGE, CRACK OR LOOSENESS OF PARTS.</li> </ol>				_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				<ol> <li>NO ELECTRICAL DISCONTINUITY OF 1μs.</li> <li>NO DAMAGE, CRACK OR LOOSENESS OF PARTS.</li> </ol>				_
SHOCK		490 m/s <sup>2</sup> DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.								_
ENVIRO	MENTAL	CHAR	ACTERISTICS							
RAPID CHA		TEMPERATURE -55 $\rightarrow$ 5 TO 35 $\rightarrow$ +85 $\rightarrow$ 5 TO 35 °C 1 CONTACT RESISTANCE: 30m $\Omega$ MAX.							$T_{v}$	
TEMPERATURE		TIME	TIME $30 \rightarrow 10 \text{ TO } 5 \rightarrow 30 \rightarrow 10 \text{ TO15 min}$ UNDER 5 CYCLES.						. X	_
DAMP HEAT		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.				③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				
(STEADY STATE) RESISTANCE TO		1) REFLOW SOLDERING				NO DEFORMATION OF CASE OF				_
SOLDERING		«REFLOW AREA»  MAX250°C WITHIN 10 sec  MIN 230°C WITHIN 60 sec  «PREHEATING AREA»  170°C to 190°C 60 sec to 120 sec  PUT THROUGH IN REFLOW FURNACE TWICE  LEAVE IN AMBIENT TEMPERATURE AND  HUMIDITY FOR 1 HOUR.  CONNECTOR TEMPERATURE TO BE  AMBIENT FOR SECOND REFLOW.  2) MANUAL SOLDERING  SOLDERING IRON TEMPERATURE :350°C,  SOLDERING TIME : 3sec.  NO STRENGTH ON CONTACT.			: :	EXCESSIVE LOOSENESS OF THE TERMINALS.				_
SOLDERABILITY			DLDERED AT SOLDER TEMPERATURE,			SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				
NOTE2: NO C NOTE3: APPL AFTE	ONDENSING Y TO THE CON	ERATURE DITION OF	FOR INSERTION DURATION RISING BY CURRENT LONG TERM STORAGE FOR L DARD, OPERATING TEMPER/	INUSED PF	RODUCTS	BEFORE MOL	JNTED	ON PCB.	X AGE DU	URING
COUN	-	SCRIPTION OF REVISIONS DES		DESIGNI	GNED CHECKED				ΛΤΕ	
$\triangle$										
Unless other	erwise specif	ied, refer	to IEC 60512.			APPRO	OVED	HS.OKAWA	18.0	4.05
						CHEC		TS.FUKUSHIMA		)4.05
						DESIG		TS.KUMAZAWA	_	04.05
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRA	DRAWN DRAWN NO.		MK.INOUE   1		04.05 <b>0</b>
нs		SPECIFICATION SHEET			PART N			DF13-*P-1.25V(75)		-
1.7	HIROSE ELECTRIC CO., LTD.				CODE N	10.	CL536		◬	1/1
<u> </u>						_	_			_